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Inventor Information for 10/810382

Petition Info

Inventor Name	City	State/Country
FANG, CHUN-LI	PINGJHEN CITY	TAIWAN
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Search Another: Application# Search or Patent# Search

PCT / Search or PG PUBS # Search

Attorney Docket # Search

Bar Code # Search

To go back use Back button on your browser toolbar.

Contents

Back to PALM | ASSIGNMENT | OASIS | Home page

US 20060245679	20061102	Electromagnetic field sensing apparatus	385/1	385/12	Liang; Wen-Lie et
Al				•	al.
US 20060242329	20061026	Power-efficient encoder architecture for data	710/3		Chen; Tien- Fu et al.
A1		stream on bus and encoding method thereof			
US 20060239044 A1	20061026	PULSE WIDTH MODULATION (PWM) CONTROLLING MODULE AND METHOD FOR ADJUSTING A PWM SIGNAL THEREOF	363/41		Chen; Tseng-Wen et al.
US 20060236706 A1	20061026	Fan control device and method	62/178	236/49.3	Hsieh; Tsung-Jung et al.
US 20060236084 A1	20061019	METHOD AND SYSTEM FOR PROVIDING AN AUXILIARY BIOS CODE IN AN AUXILIARY BIOS MEMORY UTILIZING TIME EXPIRY CONTROL	713/2		Wu; Dune- Ren et al.
US 20060227547 A1	20061012	Light guider structure	362/231		Tseng; Wen-Pao
US 20060227529 A1	20061012	DOUBLE-SIDED BACKLIGHT MODULE	362/33		Tseng; Wen-Pao et al.
US 20060226534 A1	20061012	Structure and assembly method of integrated circuit package	257/698	257/700; 257/E23.02; 257/E23.068; 438/614	Liang; Kuei-Chen et al.
US 20060220723 A1	20061005	CONTROLLING CIRCUIT FOR CONTROLLING OPERATING CLOCK AND/OR DRIVING VOLTAGE OF LOGIC CIRCUIT, AND METHOD THEREOF	327/291		Chen; Tseng-Wen et al.
US 20060203518	20060914	Light guide plate structure of backlight	362/621	362/607; 362/622	Tseng; Wen-Pao

Al		module			
US	20060914	Light guide plate	362/615		Tseng;
20060203514	2000031.	structure.			Wen-Pao
		Structure :			611 1 116
A1.		× 11	262/600	262/621	Т
US	20060914	Incident assembly of light	362/608	362/621	Tseng;
20060203511		guide plate			Wen-Pao
Al					
US	20060914	Light equalizing structure	362/30	362/29	Tseng;
20060203467		of backlight modules			Wen-Pao
		· Of backinght modules			,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
A1	20060014	D 4 1 4 4 4	252/500		Tseng;
US	20060914	Retardants on	232/300		•
20060202169		polymerization of aniline			Wen-Nan et
A1			· .		al.
US	20060907	H20 PLASMA AND H20	438/710	438/972	Lee; Yuan-
20060199393		VAPOR METHODS			Bang et al.
A1		FOR RELEASING	•		
AI		CHARGES			
TIC	20060831	APPLICATION OF	438/401	257/E21.508;	Ching; Kai-
US	20060831		430/401	•	Ming et al.
20060194407		IMPRESSED-		257/E21.582	Miling et al.
A1 .		CURRENT CATHODIC			
		PROTECTION TO			
		PREVENT METAL			
		CORROSION AND		•	
	ļ	OXIDATION			
US	20060824	Retractable keyboard	361/680	248/917	Tseng;
	20000824	Retractable Reyboard	3017080	240/71/	Wen-Chieh
20060187623					Well-Cillell
A1.					-
US	20060810	Dental cast scanning	433/49		Yau; Hong-
20060177794		apparatus	<u> </u>		Tzong et al.
A1					
US	20060810	Photo resist stripping and	216/67	438/710	Lee; Yuan-
20060175290	20000010	de-charge method for			Bang et al.
		_			Build or all.
A1		metal post etching to			
		prevent metal corrosion			****
US	20060727	Client-server-type	705/50		Wehunt;
20060167799		security system, such as a	· .		Nathan P. et
A1		security system for use			al.
		with computer network			
		consumer transactions			1
TIC	20060720		455/456.1	 	Sun; Li et
US	20000720	Distance dependent direct	1.004/664		1 '
20060160544		mode peer -to-peer			al.
A1		communication			
		establishment in a tdd			
		cdma network			
US	20060713	TILE-BASED	438/106	257/E23.062;	Fang;
20060154402		ROUTING METHOD		257/E23.07;	Chung-Yi et
20000134402		ROOTING METHOD		1231122.019	1 Silving II Ct

A1		OF A MULTI-LAYER CIRCUIT BOARD AND RELATED STRUCTURE		257/E23.079; 257/E23.114	al.
US 20060152429 A1	20060713	Antenna structure for two overlapping frequency bands	343/895	343/700MS	Pan; Sheng- Gen
US 20060139511 A1	20060629	Liquid crystal panel backlight module	349/64		Tseng; Wen-Pao et al.
US 20060124467 A1	20060615	Metal nanodot arrays and fabrication methods thereof	205/118	205/171	Ho; Rong- Ming et al.
US 20060121356 A1	20060608	Electrolyte for rechargeable battery	429/331	429/332	Jan; Yih- Song et al.
US 20060114190 A1	20060601	ACTIVE MATRIX ORGANIC ELECTRO- LUMINESCENCE DEVICE ARRAY	345/76		Fang; Chun- Hsiang et al.
US 20060110108 A1	20060525	Tunable light transceiver module	385/92		Hsieh; Tsung-Fu et al.
US 20060098454 A1	20060511	Fluorescent tubes in orthogonal array backlight module	362/614		Tseng; Wen-Pao et al.
US 20060094127 A1	20060504	Method of automatically detecting a test result of a probe zone of a test strip	436/169	235/462.13	Tseng; Wen-Chao
US 20060086967 A1	20060427	Nonvolatile memory device and method for fabricating the same	257/314	365/145	Hsieh; Tsung-Min et al.
US 20060080591 A1	20060413	Apparatus and method for automated temporal compression of multimedia content	715/500.1	715/730	Huang; Ho Chao et al.
US 20060078292 A1	20060413	Apparatus and method for embedding content information in a video bit stream	386/68	386/125	Huang; Jau Hsiung et al.
US 20060077199 A1	20060413	DYNAMIC LEVEL- ADJUSTMENT COMPENSATION CIRCUIT AND METHOD FOR DYNAMIC LEVEL-	345/211		Liao; Mu- Shan et al.

		ADJUSTMENT COMPENSATION			
US 20060072345 A1	20060406	Backlight module and flat panel display employing the same	362/633		Ho; Ya- Ting et al.
US 20060072337 A1	20060406	Backlight module having two lighting sides	362/600		Tseng; Wen-Pao et al.
US 20060072311 A1	20060406	Backlight module of a directly lighting backlight device	362/216	·	Tseng; Wen-Pao et al.
US 20060062014 A1	20060323	LCD light source projection construction	362/558		Tseng; Wen-Pao et al.
US 20060030281 A1	20060209	Method for transmit power compensation in a mobile communication terminal and communication terminal for implementing said method	455/127.1	455/522	Brunel; Roman et al.
US 20060028261 A1	20060209	Methods for controlling driving circuits	327/423		Hsieh; Tsung-Jung et al.
US 20060027654 A1	20060209	Card reader and data transmission method therefor	235/441		Chang; Chi- Tung et al.
US 20060025236 A1	20060202	Golf club head with shock absorbing material embedded therein	473/345		Tseng; Wen-Cheng
US 20060022617 A1	20060202	Backlight module for reducing interference	315/312		Liao; Mu- Shan et al.
US 20060022049 A1	20060202	Mask management method and bar code reading apparatus thereof	235/462.05		Liu; Kuo- Chung et al.
US 20060001945 A1	20060105	Spacer fabrication process for manufacturing reflective stealth mirrors and other MEMS devices	359/291		Wu; Shan- Hua et al.
US 20050267619 A1	20051201	Process and system for conveying semifinished products during LCD manufacture	700/112	700/115	Tseng, Wen Neng et al.
US	20051201	Lamp replacement	362/558	362/339	Tseng,

41

20050265043					Wen-Pao et
A1					al.
US	20051124	Serially connected thin	257/347		Chang,
20050258488	2003112.	film transistors and			Shih-Chang
A1		fabrication methods			et al.
AI		thereof			
US	20051110	Method for monitoring	356/138		Hsieh,
20050248753	20031110	slope lands and buildings	330,130		Tsung-jung
A1		on the slope lands			1500
US	20051027	Nonvolatile memory	365/63		Hsieh,
	20031027	device and method for	303/03		Tsung-Min
20050237777					et al.
A1	20051027	fabricating the same	345/204	 	Huang,
US	20051027	Image processing method	343/204		Juin-Ying et
20050237316		for a TFT LCD	1	· .	al.
A1	00051055	TT: 1 C	136/263	257/051 02	Yang, Yang
US	20051027	High-performance and	136/263	257/E51.03;	
20050236035		low-cost plastic solar		257/E51.031;	et al.
A1		cells		257/E51.039;	
				438/82	7 01
US	20051020	Toxic waste receptacle	220/252	220/908	Fang, Chun-
20050230407		·			Li et al.
A1					
US	20051013	Semiconductor	705/37		Fang,
20050228737		manufacturing capacity			Chung-
A1		features exchange system			Chien
US	20051013	METHOD FOR	324/771		Chen,
20050225351		DETECTING A POWER			Tseng-Wen
Al		LOAD OF A POWER			et al.
		SUPPLY MODULE			
		ACCORDING TO			
		DUTY CYCLE			
		DETECTION, AND			
		RELATED DEVICE			·
US	20051006	Configuring apparatus	228/49.4	228/6.1	Huang,
20050218190		and processing method of			Meng-
Al		thermal conductive plate		,	Cheng et al.
US	20050922	Shock-absorbing golf	473/345		Tseng,
20050209023	20030722	club head			Wen-Cheng
A1					
US	20050908	LCD optical waveguide	385/146		Tseng,
20050196122	20030908	device	303/110		Wen-Pao
		device			
A1	20050008	Dimmer device for	362/561	362/560	Tseng,
US	20050908		302/301	302/300	Wen-Pao
20050195619		backlight module			VV CII-1 ao
A1	00050005	Calfalah haadaad	473/345	473/349	Tseng,
US	20050825	Golf club head and	14/3/343	4131347	1 seng,

	method of fabricating the			Wen-Cheng
	same			
20050825	Method and apparatus for	73/756		Jang, Ruei-
				Hung et al.
	wand			
20050811	Method for	257/79		Chang, Pan-
	manufacturing light			Tzu et al.
				i
	metal bonding technology			
	and structure thereof			
20050728	Solid electrolytic	361/523		Tseng, Wen
	capacitor, fabrication			Nan et al.
	method thereof, and			
	coupling agent utilized in	•		
	the same			·
20050721	Computing apparatus	710/74	710/301	Chen,
				Chong-
<u>.</u>				Kuang et al.
20050721	_	438/8		Tseng,
	detection system		134/902	Wen-Song
				et al.
20050721		369/275.2		Yeh, Tung-
	recording medium			Ti et al.
20050505	S	165/104.11	257/E22 000	Lluona
20050707		165/104.11	23 //E23.088	Huang, Meng-
				Cheng et al.
20050620		702/100		Lin, Syh-
20030630		702/190	1	Shoei et al.
				Shoci et al.
20050620		173/332	473/342	Tseng,
20030030		473/332		Wen-Cheng
	Club fiead			Wen eneng
20050630	SOLID	361/525	1737330	Tseng, Wen
20030030		301/323		Nan et al.
				1
	1			
	,			
		•		
20050630		228/33	228/256	Chien,
	1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -	1	1	· ·
	apparatus and method of			Chih-Hsien
	20050728	20050825 Method and apparatus for measuring gripping strength of a vacuum wand 20050811 Method for manufacturing light emitting diode utilizing transparent substrate and metal bonding technology and structure thereof 20050728 Solid electrolytic capacitor, fabrication method thereof, and coupling agent utilized in the same 20050721 Computing apparatus including a hardware management add-on card 20050721 Wet bench wafer floating detection system 20050721 Phase change optical recording medium 20050707 Structure of a uniform thermal conductive heat dissipation device 20050630 Universal power measurement SoC and measuring method 20050630 Shock-absorbing golf club head 20050630 SOLID ELECTROLYTIC CAPACITOR, FABRICATION METHOD THEREOF, AND COUPLING AGENT UTILIZED IN THE SAME	same 20050825 Method and apparatus for measuring gripping strength of a vacuum wand 20050811 Method for manufacturing light emitting diode utilizing transparent substrate and metal bonding technology and structure thereof 20050728 Solid electrolytic capacitor, fabrication method thereof, and coupling agent utilized in the same 20050721 Computing apparatus including a hardware management add-on card 20050721 Wet bench wafer floating detection system 20050721 Phase change optical recording medium 20050707 Structure of a uniform thermal conductive heat dissipation device 20050630 Universal power measurement SoC and measuring method 20050630 Shock-absorbing golf club head 20050630 SOLID ELECTROLYTIC CAPACITOR, FABRICATION METHOD THEREOF, AND COUPLING AGENT UTILIZED IN THE SAME	Same 20050825 Method and apparatus for measuring gripping strength of a vacuum wand 20050811 Method for manufacturing light emitting diode utilizing transparent substrate and metal bonding technology and structure thereof 361/523 20050728 Solid electrolytic capacitor, fabrication method thereof, and coupling agent utilized in the same 20050721 Computing apparatus including a hardware management add-on card 438/8 134/1.3; 134/902 20050721 Phase change optical recording medium 20050721 Phase change optical recording medium 257/E23.088 2

US 20050113185	20050526	Golf club head with a vibration-absorbing	473/332	473/345; 473/349	Tseng, Wen-Cheng
US 20050084736 A1	20050421	Fuel cells for use in portable devices	429/38	429/32; 429/34	Chang, Shung-Huei et al.
US 20050082556 A1	20050421	InGaN-based led	257/96		Sung, Ying- Che et al.
US 20050081697 A1	20050421	Diamond circular saw blade	83/835	30/350; 83/666	Liao, Chien- Cheng et al.
US 20050078364 A1	20050414	[TELESCOPE]	359/410	359/399	Tseng, Wen-Tso et al.
US 20050074914 A1	20050407	Semiconductor device and method of fabrication the same	438/48	257/E21.413; 257/E21.703; 257/E27.111; 257/E29.278; 257/E29.279	Chang, Shih-Chang et al.
US 20050066633 A1	20050331	Method and apparatus for filtering contaminants	55/385.2	, .	Jang, Ruei- Hung et al:
US 20050057480 A1	20050317	Gate driving circuit of LCD	345/98		Liao, Mu- Shan et al.
US 20050057476 A1	20050317	Method and circuit for driving liquid crystal display	345/92		Lin, Ching- Wei et al.
US 20050053808 A1	20050310	Method and system for improving efficiency of fuel cell in portable devices	429/13	429/26; 429/30; 429/38	Chang, Shung-Huei et al.
US 20050050080 A1	20050303	Flexible apparatus for setting configurations using an EEPROM	707/100		Tseng, Wen-Cheng et al.
US 20050049075 A1	20050303	Weight member for a golf club head			Chen, Chan-Tung et al.
US 20050049074 A1	20050303	Weight member for a golf club head		473/337; 473/338	Chen, Chan-Tung et al.
US 20050041296 A1	20050224	High transmittance overcoat for microlens arrays in semiconductor color imagers	359/619	257/E31.128	Hsiao, Yu- Kung et al.

US	20050224	Storage cell supplying	320/111		Tseng, Wen
20050040788 A1		power of different voltages			Ing
US 20050019168 A1	20050127	Fan motor speed control circuit	417/44.1		Huang, Wen-Shi et al.
US 20040265548 A1	20041230	Nanopatterned templates from oriented degradable diblock copolymer thin films	428/195.1	427/256; 428/480	Ho, Rong- Ming et al.
US 20040255457 A1	20041223	TILE-BASED ROUTING METHOD OF A MULTI-LAYER CIRCUIT BOARD AND RELATED STRUCTURE	29/846	257/E23.062; 257/E23.07; 257/E23.079; 257/E23.114; 29/830; 29/842	Fang, Chung-Yi et al.
US 20040245549 A1	20041209	Thin film transistor and fabrication method thereof	257/202	257/E21.413; 257/E21.703; 257/E29.137; 257/E29.278	Chang, Shih-Chang et al.
US 20040232239 A1	20041125	Method of automatically detecting a test result of a probe zone of a test strip	235/462.01		Tseng, Wen-Chao
US 20040227195 A1	20041118	Self-aligned LDD thin- film transistor and method of fabricating the same	257/408	257/E21.413; 257/E29.275; 257/E29.278	Chang, Shih-Chang et al.
US 20040215843 A1	20041028	Network device having a flexible EEPROM for setting configuration settings	710/10	709/222	Tseng, Wen-Cheng et al.
US 20040206963 A1	20041021	Method for manufacturing light emitting diode utilizing transparent substrate and metal bonding technology and structure thereof	257/79		Chang, Pan- Tzu et al.
US 20040203205 A1	20041014	Method of forming tiny silicon nitride spacer for flash EPROM by fully wet etching technology	438/257	257/E21.209	Liu, Hung- Hsin et al.
US 20040197123 A1	20041007	HOLDER FOR VARIABLE-SIZED IMAGE RECORDING MEDIUMS	399/377		Tseng, Wen-Chao
US	20041007	Manufacturing method of	216/2		Chao, Chih-

		•			
•					
					Yu et al.
20040195201		light-guiding apparatus			l u et al.
A1		for using in backlight of			
TIO	20040020	liquid crystal display	438/745		Jang, Ruei-
US	20040930	Method and apparatus for homogeneous mixing	436/743		Hung et al.
20040192064		nomogeneous mixing			Trung et ai.
A1	20040916	GOLF CLUB STRIKING	473/342	473/345;	Tseng,
US	20040916	FACE WITH VARIED	4737342	473/349	Wen-Cheng
20040180731		THICKNESS	1	4737347	Wentending
Al		DISTRIBUTION			
US	20040909	Scanner integrated circuit	345/100		Huang,
20040174330	20040303	Scame megrated eneur	3437100		Juin-Ying et
A1					al.
US	20040805	Non-rubbing liquid	264/494	264/236;	Chao, Chih-
20040150141	20040803	crystal alignment method	201/151	264/293;	Yu et al.
A1		Crystal alignment method		427/256;	
Al		•		427/355;	
				427/58	
US	20040729	Method for fabricating	438/612	257/E21.508;	Chang,
20040147105		microelectronic product		438/597	Chih-Kung
Al		with attenuated bond pad			et al.
	-	corrosion			
US	20040722	Scanner and scanning	271/3.05		Tseng,
20040140605		method having adjustable			Wen-Chao
A1		length of turn region		·	
US	20040715	Data encryption and	713/193		Yeh, Ming-
20040139339		decryption method and			Fong et al.
A1		apparatus			
US	20040715	METHOD TO REMOVE	134/1	134/10;	Lu, Kuo-
20040134513		PARTICULATE		134/34	Liang et al.
A1		CONTAMINATION	1		
		FROM A SOLUTION			
		BATH	172/206		Tana
US	20040708	GOLF CLUB AND A	473/306		Tseng, Wen-Cheng
20040132540		METHOD FOR			wen-Cheng
A1		ASSEMBLING THE		İ	
	20040700	GOLF CLUB	385/12	324/96	Liang,
US	20040708	Miniature antenna and	363/12	324/30,	Wen-Lie et
20040131301		electromagnetic field			al.
A1 US	20040610	sensing apparatus Heat dissipator	165/80.3	165/121;	Horng, Alex
20040108100		i icai dissipatoi	103/00.3	165/80.2;	et al.
A1				257/E23.099	1
US	20040520	User interface of an	345/619		Tseng,
20040095360	1	image capturing	3.5,019	İ	Wen-Chao
A1		apparatus and an image			et al.
/\lambda1		apparatus and an image		_	

		processing method thereof			
US 20040087175 A1	20040506	Application of impressed- current cathodic protection to prevent metal corrosion and oxidation	438/746	257/E21.508; 257/E21.582	Ching, Kai- Ming et al.
US 20040080793 A1	20040429	Method for correcting negative film image with nagative film interval	358/487	382/319	Tseng, Wen-Chao
US 20040075610 A1	20040422	Pifa antenna apparatus for mobile communications terminals	343/700MS		Pan, Sheng- Gen
US 20040074600 A1	20040422	WET ETCH SYSTEM WITH OVERFLOW PARTICLE REMOVING FEATURE	156/345.18		Jang, Ruei- Hung et al.
US 20040066541 A1	20040408	Scanner with a lateral reversing device	358/474		Tseng, Wen-Chao et al.
US 20040053994 A1	20040318	Laetispicine and laetispicine analogues, methods of use and preparation	514/464	549/441	Pan, Sheng- li et al.
US 20040051672 A1	20040318	Mobile telephone comprising a multi-band antenna	343/702	343/895	Nevermann, Peter et al.
US 20040047516 A1	20040311	Image correction method	382/274		Tseng, Wen-Chao
US 20040046702 A1	20040311	Quad-band mobile radio antenna	343/742	343/867	Pan, Sheng- Gen
US 20040043524 A1	20040304	Method for fabricating light emitting diode with transparent substrate	438/26	438/46; 438/47	Huang, Wen-Chieh et al.
US 20040041321 A1	20040304	Suction device with telescopic evacuating pipes	269/21		Hsieh, Tsung- Chang
US 20040037425 A1	20040226	Method for realizing virtual multi-channel output by spectrum analysis	381/19	381/18; 381/23	Yeh, Ta- Jung et al.
US 20040035621	20040226	Scooter	180/181		Yu, Fang- Chun

Al					
US 20040035616 A1	20040226	Scooter	180/65.1	180/181	Yu, Fang- Chun
US 20040027620 A1	20040212	Double-side image scanner and scanning method of the same	358/474	358/488; 358/496; 358/498	Tseng, Wen-Chao
US 20040023470 A1	20040205	Novel material to improve image sensor yield during wafer sawing	438/460	257/E21.599; 438/113; 438/464	Hsu, Hung- Jen et al.
US 20040008981 A1	20040115	IN-LINE FLUID HEATER	392/424	392/422	Woo, Tien- Hsing et al.
US 20040000375 A1	20040101	Plasma etch chamber equipped with multi-layer insert ring	156/345.3	156/345.1; 156/345.48	Liu, Hsiang- Hsing et al.
US 20030233229 A1	20031218	Digital audio signal processing method with improved processing efficiency	704/212	5	Tseng, Wen-Long et al.
US 20030211427 A1	20031113	Method and apparatus for thick film photoresist stripping	430/329	134/147; 134/2	Tseng, Wen- Hsiang et al.
US 20030209260 A1	20031113	Ferris wheel-like stripping or cleaning mechanism for semiconductor fabrication	134/32	134/158; 134/161; 134/902	Ching, Kai- Ming et al.
US 20030196684 A1	20031023	Flush system for dry film photoresist remover	134/10	134/111; 134/169R; 134/22.18	Lin, Ta-Min et al.
US 20030196006 A1	20031016	Network device having a flexible EEPROM for setting configuration settings	710/8		Tseng, Wen-Cheng et al.
US 20030196005 A1	20031016	Flexible apparatus for setting configurations using an EEPROM	710/8		Tseng, Wen-Cheng et al.
US 20030183308 A1	20031002	Method for electroplated metal annealing process	148/518	148/525; 257/E21.175	Yang, Neng-Hui et al.
US 20030182127 A1	20030925	Low speed speech encoding method based on internet protocol	704/270.1	704/211	Pan, Shengxi et al.

US	20030918	Method and apparatus for	382/233		Hsieh,
20030174895		decoding compressed			Tsung-
A1		image data and capable of			Hsien
		preventing error			
		propagation			
US	20030828	Monolithic microwave	257/728	257/E23.105	Hsieh,
20030160322		integrated circuit package			Tsung-Ying
A1		having thermal via			et al.
US	20030814	DYNAMIC BALANCE	473/306		Tseng,
20030153398	2003001.	MECHANISM FOR A			Wen-Cheng
A1		GOLF CLUB			_
US	20030724	Drain garbage collector	210/163		Tseng, Wen
20030136717	20030721	Draw garouge consesses			Ching
A1				,	
US	20030717	Semiconductor device	257/377	257/344;	Hsieh,
20030132486	20030717	structure	20.7.0.7.	257/369;	Tsung-
A1		Structure	• •	257/E21.438;	Hsuan et al.
				257/E21.62;	
				257/E21.622;	
				257/E29.136	
US	20030703	Method of making a	438/613	257/E21.508;	Tseng, Li-
20030124832	20030703	bump on a substrate	100/010	257/E23.021	Hsin et al.
			,		
	20030703		210/774		Jang, Ruei-
	20030703		210,,,,		
		i temoving system			
	20030626	Abrasive helt material for	451/296		Yu, Fang-
	20030020		10 27 27 3		Chun
			1	-	
	20030626		438/615	257/E21.508;	Chiu, Chih-
	20030020		100,010		Cheng et al.
AI					
TIS	20030529		438/106	257/E33.066:	Lin, Ming-
	20030327	·		257/E33.072;	Der et al.
1		1			
		Prince and the		438/29	
IIS	20030529	MOS-based voltage	327/543		Hsieh,
	2005052	-			Tsung
					Hsuan et al.
	20030529	Circuit and method for	324/548		Hsieh,
	_				Tsung
					Hsuan et al.
US	20030522	Filler for airtight	137/588		Kuo, Wen-
US 20030121869 A1 US 20030119432 A1 US 20030119300 A1 US 20030100140 A1 US 20030098740 A1 US 20030098695 A1	20030703 20030626 20030626 20030529 20030529 20030529	without ribbon residue Thermophoretic particle removing system Abrasive belt material for grinding/polishing/cutting tools METHOD OF MAKING A BUMP ON A SUBSTRATE USING MULTIPLE PHOTORESIST LAYERS Method for packaging a high efficiency electro- optics device MOS-based voltage reference circuit Circuit and method for measuring capacitance Filler for airtight	324/548	438/123;	Chiu, Chih Cheng et a Lin, Ming- Der et al. Hsieh, Tsung Hsuan et a Hsieh, Tsung Hsuan et a

20030094205		container			Chang et al.
A1					·
US	20030501	Method for comprising	382/232		Tseng,
20030081839		an image in real time			Wen-Chao
A1		·			77 17
US	20030417	Diamond grinding wheel	451/541		Yu, Fang-
20030073396					Chun
Al				0.50/406	T: D
US	20030417	Optical scanner equipped	358/474	358/406	Liu, Rong-
20030072039		with plug-in calibration			Ji et al.
A1		film			Cil
US	20030410	METHOD OF	399/35		Coriale,
20030068167		DETECTING WASTE			Matthew
A1		TONER IN A			Christopher
		CONTAINER OF AN			et al.
		IMAGE FORMING		- (1)	
		APPARATUS	250/106		II Vin
US	20030320	Method for capturing	359/196		Huang, Yin- Chun et al.
20030053183		images useful in a			Chun et al.
A1		scanning system	121/244		Hsieh,
US	20030313	Gas supply apparatus for	431/344	٠.	1 1
20030049579		a gas fired radiant heater			Tsung-Han
A1	2002020	71 . 1	266/1652	366/340	Jang, Ruei-
US	20030306	Fluid mixing apparatus	366/165.2	300/340	Hung et al.
20030043689					Trung ct ar.
Al	20020220	North ad facility marries that	438/778	257/E21.259;	Hsieh,
US	20030220	Method for improving the	430///0	257/E21.235, 257/E21.576;	Tsung-Tang
20030036290		coating capability of low-		438/758;	et al.
A1		k dielectric layer		438/780;	
				438/781;	
		·		438/782	
US	20030220	METHOD OF A	427/569	257/E21.259;	Hsieh,
20030035904	20030220	SURFACE	1277307	257/E21.266;	Tsung-Tang
A1		TREATMENT IN		257/E21.293;	et al.
AI		IMPROMOVING		427/240;	
		ADHESION OF AN		427/255.28;	
		ORGANIC		427/402	
·		POLYMERIC LOW-K			
		DIELECTRIC LAYER			
US	20021219	Fluid leak detection via	73/40	340/605	Jang, Ruei-
20020189326		thermal sensing			Hung et al.
A1					
US	20021205	METHOD FOR	438/623	257/E21.261	Hsieh,
20020182849		FABRICATING A LOW			Tsung-Tans
A1		DIELECTRIC			et al.
: A I	1	DIEDECTRIC	1::-		1 34 4

		CONSTANT			
	í ,	MATERIAL LAYER		1	1
US 20020180062 A1	20021205	FLIP CHIP PACKAGE OF MONOLITHIC MICROWAVE INTEGRATED CIRCUIT	257/778	257/E21.511	Hsieh, Tsung-Ying et al.
US 2002016903 <u>2</u> A1	20021114	Golf club	473/307	473/312	Tseng, Wen-Cheng
US 20020163774 A1	20021107	TCNQ complex and its application in solid electrolytic capacitors	361/523		Tsai, Li- Duan et al.
US 20020162579 A1	20021107	Wet stripping apparatus and method of using	134/26	134/105; 134/137; 134/32; 134/902	Wang, Yu- Hsi et al.
US 20020151378 A1	20021017	Golf club with a weight member	473/316		Tseng, Wen-Cheng
US 20020151375 A1	20021017	Golf club	473/305		Tseng, Wen-Cheng
US 20020140274 A1	20021003	CHAIR HAVING A REINFORCED ATTACHING MECHANISM	297/445.1	,	Gien, Gin Chong et al.
US 20020140081 A1	20021003	Highly integrated multi- layer circuit module having ceramic substrates with embedded passive devices	257/700	257/698; 257/703; 257/758; 257/774; 257/924; 257/E23.062; 257/E23.069; 438/118; 438/125; 438/622; 438/629	Chou, Young- Huang et al.
US 20020137575 A1	20020926	Golf club	473/305	473/312	Tseng, Wen-Cheng
US 20020131726 A1	20020919	Method and structure for packaging a high efficiency electro-optics	385/88	257/E33.066; 257/E33.072; 385/14	

20020129321		circuit for analog signals			Shoei et al.
A1					
US	20020829	Imaging rotation cup	434/365		Yeh, Hsieh-
20020119436				,	Tsung
A1	20020510		245/610	·	Trang Wan
US	20020718	Programmable interface	345/619		Tseng, Wen Nan
20020093512					INall
Al	20020711	Multi-frequency band	343/702	343/700MS;	Tseng,
US 20020089453	20020711	antenna	343/702	343/895	Wen-Jen et
A1				343/023	al.
US	20020620	Method of removaling	438/694		Fang, Chun-
20020076934	20020020	photoresistance	130/051		Chieh et al.
A1		photoresistance			
US	20020530	Selective electroplating	430/311	205/118;	Ching, Kai-
20020064729		method employing	:	205/123;	Ming et al.
Al	1	annular edge ring cathode		205/125;	·
		electrode contact		257/E21.175;	
			, Y	257/E21.508;	
		, , , , , , , , , , , , , , , , , , , ,		430/322	
US	20020530	Contaminant inspecting	356/237.2		Tseng, Wen
20020063861		device with multi-color		-	Nan
Al		light source	2.42/225	242/700) (C	T
US	20011122	Chip antenna	343/895	343/700MS;	Tseng, Wen-Jen et
20010043161				343/702	al.
Al	20010628	Antenna and method for	343/909	343/908;	Nevermann,
US	20010628	producing an antenna	343/303	343/914	Peter et al.
20010005183 A1		producing an amenna		343/711	Total of all
US 7123353	20061017	Method for monitoring	356/138	356/139.1	Hsieh;
B2	20001017	slope lands and buildings	330/130		Tsung-Jung
, .		on the slope lands			
US 7122260	20061017	Method and system for	429/13	429/26	Chang;
B2		improving efficiency of			Shung-Huei
		fuel cell in portable			et al.
		devices			
US 7119394	20061010	Nonvolatile memory	257/316	257/317;	Hsieh;
B2		device and method for		257/321;	Tsung-Min
		fabricating the same	0.60/5.5	257/324	et al.
US 7118264	20061010	Backlight module having	362/561	349/58;	Tseng;
B2		two lighting sides		349/62;	Wen-Pao et
				349/65; 362/612;	al.
				362/612;	
				362/632	
	1	į.	1	JUL 0J4	1
US 7106010	20060912	Backlight module for	315/312	315/159;	Liao; Mu

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B2		reducing interference		315/169.4;	Shan et al.
				345/102	
US 7104671	20060912	Lamp replacement	362/224	362/558;	Tseng;
B2				362/613;	Wen-Pao et
		·		362/633;	al.
			•	362/652;	
				362/656	
US 7102575	20060905	PIFA antenna apparatus	343/702	343/700MS;	Pan; Sheng-
B2	,	for mobile	_	343/767	Gen
		communications	•		
		terminals			
US 7097103	20060829	Method of automatically	235/462.13	235/375;	Tseng;
B2		detecting a test result of a		235/462.01;	Wen-Chao
		probe zone of a test strip		235/462.15;	
		_		235/494;	
			•	422/58;	
				435/4	
US 7088879	20060808	Miniature antenna and	385/12	343/748	Liang;
B2		electromagnetic field			Wen-Lie et
		sensing apparatus			al.
US 7086964	20060808	Weight member for a golf	473/350	473/324	Chen;
B2		club head	,		Chan-Tung
					et al.
US 7071032	20060704	Material to improve	438/113	438/460	Hsu; Hung-
B2		image sensor yield during			Jen et al.
		wafer sawing			
US 7043828	20060516	Tile-based routing	29/830	174/260;	Fang;
B2		method of a multi-layer		174/262;	Chung-Yi et
		circuit board	ļ	257/E23.062;	al.
				257/E23.07;	
				257/E23.079;	
•		į		257/E23.114;	
				29/825;	
				29/831;	<u> </u>
				29/846;	
				438/106	
US 7040524	20060509	Automated packaging	228/33	228/48;	Chien;
B2		apparatus and method of		228/53	Chih-Hsien
	1	optical elements			et al.
US 7036342	20060502	Yarn feeder	66/136		Hsieh;
B1		·			Tsung-
					Hung
US 7031854	20060418	Universal power	702/60	324/142;	Lin; Syh-
B2		measurement SoC and		702/64	Shoei et al.
		measuring method			
US 7031028	20060418	Optical scanner equipped	358/406	358/474;	Liu; Rong-

B2		with plug-in calibration film		358/475; 358/483; 358/497; 358/505;	Ji et al.
US 7020018 B2	20060328	Nonvolatile memory device and method for fabricating the same	365/185.03	358/506 365/185.17; 365/63	Hsieh; Tsung-Min et al.
US 7015716 B2	20060321	Method for detecting a power load of a power supply module according to duty cycle detection, and related device	324/771	324/158.1; 324/537; 324/765	Chen; Tseng-Wen et al.
US 7009772 B2	20060307	High transmittance overcoat for microlens arrays in semiconductor color imagers	359/619	257/E31.128; 359/248; 359/620; 359/626	Hsiao; Yu- Kung et al.
US 7005079 B2	20060228	Manufacturing method of light-guiding apparatus for using in backlight of liquid crystal display	216/42	216/23; 216/79; 216/80; 430/313; 430/5	Chao; Chih- Yu et al.
US 6991560 B2	20060131	Golf club head with a vibration-absorbing structure	473/332	473/346; 473/350	Tseng; Wen-Cheng
US 6971270 B2	20051206	Method and apparatus for measuring gripping strength of a vacuum wand	73/714		Jang; Ruei- Hung et al.
US 6947887 B2	20050920	Low speed speech encoding method based on Internet protocol	704/211	370/352; 704/220; 704/223; 709/238	Pan; Shengxi et al.
US 6932076 B2	20050823	Diamond circular saw blade	125/15	125/18; 125/22	Liao; Chien- Cheng et al.
US 6926818 B1	20050809	Method to enhance the adhesion between dry film and seed metal	205/123	205/209; 205/224; 438/598; 438/612; 438/760	Lin; Yih- Ann et al.
US 6920036 B1	20050719	Solid electrolytic capacitor, fabrication method thereof, and coupling agent utilized in the same	361/525	361/524; 361/528	Tseng; Wen Nan et al.

US 6918397	20050719	Flush system for dry film	134/22.18	134/10;	Lin; Ta-Min
B2	20030719	photoresist remover	134/22.10	134/104.1;	et al.
B2		photoresist remover		134/111;	ct ai.
				· ·	
				134/22.11;	
				134/22.12	
US 6911097	20050628	Photoresist stripper using	134/31	134/102.2;	Chen; Chie-
B1		nitrogen bubbler		134/2;	Chi et al.
				134/25.1;	
•				134/25.4;	
		Ì		134/34;	
				134/37;	
				438/906	
US 6908813	20050621	Method of forming tiny	438/257	257/E21.209;	Liu; Hung-
B2	20030021	silicon nitride spacer for		438/689;	Hsin et al.
D2		flash EPROM by fully		438/745	
		wet etching technology		150,7.15	
110 (005110	20050517	Method and apparatus for	382/233	382/245	Hsieh;
US 6895119	20030317		362/233	302/243	Tsung-
B2		decoding compressed			Hsien
		image data and capable of			risicii
		preventing error			
		propagation		0.5577701.050	** **
US 6878642	20050412	Method to improve	438/759	257/E21.252;	Hsu; Hung-
B1		passivation openings by		438/760	Jen et al.
-		reflow of photoresist to			
		eliminate tape residue			
US 6871702	20050329	Heat dissipator	165/104.33	165/121;	Horng;
B2		_		165/80.3;	Alex et al.
7				257/E23.099;	
]		•	361/697;	
				361/700	
US 6858648	20050222	Laetispicine and	514/464	514/466;	Pan; Sheng-
B2	20030222	laetispicine analogues,		549/441	li et al.
D2		methods of use and			
		preparation			
US 6853352	20050208	Mobile telephone	343/895	343/702	Nevermann;
	20030208	_	343/6/3	343/702	Peter et al.
B2		including a multi-band	• • •		1 ctcr ct ai.
VIO 6010500	20050201	antenna	120/612	257/E21.508;	Chang;
US 6849533	20050201	Method for fabricating	438/612		
B2		microelectronic product		438/29;	Chih-Kung
		with attenuated bond pad		438/618;	et al.
		corrosion		438/622;	-
				438/624	77
US 6827835	20041207	Method for electroplated	205/220	205/157;	Yang;
B2		metal annealing process		205/225;	Neng-Hui et
			•	1 0 5 5 70 0 1 1 7 5	1 1
i .	ļ ·			257/E21.175; 427/533;	al.

				438/758	
US 6821810	20041123	High transmittance	438/69	257/432;	Hsiao; Yu-
B1	20011120	overcoat for optimization		257/435;	Kung et al.
		of long focal length		257/436;	_
		microlens arrays in		257/E31.128;	
		semiconductor color		438/60;	
		imagers		438/70;	
		Imagers		438/71;	
				438/72;	
**				438/75	
US 6813821	20041109	Manufacturing method	29/527.6	29/447;	Tseng;
	20041109	for a golf club head	2)/32/.0	29/458;	Wen-Cheng
B1		lor a gori ciub nead		29/464;	, on oneng
				29/527.3;	•
				473/305	
TIC (000020	20041005	Golf club striking face	473/329	473/342;	Tseng;
US 6800039	20041005	with varied thickness	4131329	473/345;	Wen-Cheng
B1				473/349	
110 (50505	20040020	distribution	134/32	134/142;	Ching; Kai-
US 6797075	20040928	Ferris wheel-like	134/32	134/142,	Ming et al.
B2		stripping or cleaning		1	Willing et al.
		mechanism for	•	134/33	
		semiconductor			'
		fabrication	204/65	204/01 21	TT 1.
US 6796588	20040928	Suction device with	294/65	294/81.21	Hsieh;
B2		telescopic evacuating			Tsung-
		pipes	10.1/1.0	124/1 124/2	Chang
US 6796315	20040928	Method to remove	134/1.3	134/1; 134/2;	Lu; Kuo-
B2		particulate contamination		134/26;	Liang et al.
		from a solution bath		134/28;	
				134/29;	
	ļ			134/3;	
				134/902	
US 6769996	20040803	Golf club and a method	473/306	473/312;	Tseng;
B2		for assembling the golf	1	473/345	Wen-Cheng
		club			
US 6764965	20040720	Method for improving the	438/782	257/E21.259;	Hsieh;
B2		coating capability of low-		257/E21.576;	Tsung-Tang
		k dielectric layer		427/489;	et al.
				427/503;	
				427/579;	
				438/780;	
				438/781;	
				438/789;	
				438/790	
US 6759276	20040706	Material to improve	438/114	.438/460;	Hsu; Hung-
		-		438/464	Jen et al.
US 675927 <u>6</u> B1	20040706	CMOS image sensor	430/114	1	-

		yield during wafer sawing			
US 6752897 B2	20040622	Wet etch system with overflow particle removing feature	156/345.11	134/113	Jang; Ruei- Hung et al.
US 6738833 B2	20040518	Network device having a flexible EEPROM for setting configuration settings	710/8	709/220; 709/221; 709/222; 710/10; 710/5; 710/9	Tseng; Wen-Cheng et al.
US 6712260 B1	20040330	Bump reflow method by inert gas plasma	228/180.22	228/205; 228/219; 228/220; 257/E21.508; 438/613	Kuo; Wen- Chang et al.
US 6696356 B2	20040224	Method of making a bump on a substrate without ribbon residue	438/612	257/E21.508; 257/E23.021; 438/613; 438/781	Tseng; Li- Hsin et al.
US 6696325 B1	20040224	Method of transferring a thin film device onto a plastic sheet and method of forming a flexible liquid crystal display	438/149	257/E21.567; 438/459; 438/977	Tsai; Yaw- Ming et al.
US 6691738 B2	20040217	Filler for airtight container	137/588	141/332; 141/346; 251/148	Kuo; Wen- Chang et al.
US 6687456 B1	20040203	In-line fluid heater	392/424	392/376	Woo; Tien- Hsing et al.
US 6686292 B1	20040203	Plasma etch method for forming uniform linewidth residue free patterned composite silicon containing dielectric layer/silicon stack layer	438/710	257/E21.218; 257/E21.231; 257/E21.252; 257/E21.257; 438/723; 438/724; 438/725	Yang; Szu- Hung et al.
US 6686218 B2	20040203	Method for packaging a high efficiency electro- optics device	438/29	257/E33.066; 257/E33.072; 438/107	Lin; Ming- Der et al.
US 6685842 B2	20040203	Thermophoretic particle removing system	210/775	210/176	Jang; Ruei- Hung et al.
US 6683352 B2	20040127	Semiconductor device structure	257/377	257/342; 257/344; 257/368; 257/369; 257/370;	Hsieh; Tsung- Hsuan et al.

		····		0.55/0.50	
			ŕ	257/372;	
				257/378;	
				257/E21.438;	
				257/E21.62;	
	0.			257/E21.622;	
				257/E29.136	
US 6663007	20031216	Common socket device	235/487	235/441;	Sun; Chun-I
B1		for memory cards		361/737	et al.
US D483467	20031209	Heat-dissipation fan	D23/379		Horng;
S	20001207				Alex et al.
US 6660641	20031209	Method for forming crack	438/699	257/E21.244;	Kuo; Chin
	20031209		130/077	430/314	Chen et al.
B1		resistant planarizing layer		430/314	Chen et al.
		within microelectronic			
	·	fabrication			
US D483114	20031202	Heat-dissipation fan	D23/411		Horng;
S		assembly			Alex et al.
US D483113	20031202	Heat-dissipation fan	D23/411		Horng;
S		1			Alex et al.
US D483107	20031202	Heat-dissipation fan	D23/379		Horng;
-	20031202	Treat-dissipation fair	D23/3/7		Alex et al.
S	20021202	TT / 1'	361/709	165/80.3;	Tseng; Wen
US 6657865	20031202	Heat dissipating structure	301/709	<u>-</u>	•
B1				174/16.3;	Hai et al.
				257/722;	1
				257/E23.099;	
		·		257/E23.103;	
				361/704;	
		· .		361/710	Φ.
110 ((20(00	20021028	Calactive electropleting	430/311	205/105;	Ching; Kai-
US 6638688	20031028	Selective electroplating	430/311	1	Ming et al.
B2		method employing	İ	205/122;	Ming et al.
		annular edge ring cathode		205/135;	
		electrode contact		250/492.2;	
		*		250/492.22;	
*				257/E21.175;	
				257/E21.508;	
				430/322;	
				1	
				430/396;	
			1 - 10 - 1	430/5	T.
US 6638178	20031028	Golf club	473/306	473/312	Tseng;
B2					Wen-Cheng
US 6634957	20031021	Golf club with a weight	473/306		Tseng;
B2		member			Wen-Cheng
US 6623912	20030923	Method to form the ring	430/314	430/311	Ching, Kai-
B1	20030723	shape contact to cathode		1	Ming et al.
וען		on wafer edge for			3 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2
		electroplating in the			
		bump process when using		J	

		the negative type dry film photoresist			
US 6620054 B2	20030916	Dynamic balance mechanism for a golf club	473/306	473/309; 473/312	Tseng; Wen-Cheng
US 6620053 B2	20030916	Golf club	473/297	473/306; 473/307; 473/312	Tseng; Wen-Cheng
US 6603151 B2	20030805	Method and structure for packaging a high efficiency electro-optics device	257/98	257/100; 257/103; 257/676; 257/77; 257/99; 257/E33.066; 257/E33.072	Lin; Ming- Der et al.
US 6601986 B2	20030805	Fluid mixing apparatus	366/165.2	366/340	Jang; Ruei- Hung et al.
US 6599826 ⁻ B2	20030729	Method for fabricating a low dielectric constant material layer	438/623	257/E21.261; 438/628; 438/778; 438/780	Hsieh; Tsung-Tang et al.
US 6592323 B1	20030715	Plate member carrier	414/737	198/471.1; 198/750.12; 414/729; 414/732; 414/733; 414/738; 414/917; 901/12; 901/40	Hsieh; Tsung- Chang
US 6586322 B1	20030701	Method of making a bump on a substrate using multiple photoresist layers	438/612	257/E21.508; 438/613; 438/614; 438/615	Chiu; Chih- Cheng et al.
US 6582988 B1	20030624	Method for forming micro lens structures	438/70	438/72	Hsiao; Yu- Kung et al.
US 6580881 B2	20030617	Method of detecting waste toner in a container of an image forming apparatus	399/35	399/27	Coriale; Matthew Christopher et al.
US 6577191 B2	20030610	Automatic gain control circuit for analog signals	330/136	330/140; 330/144; 330/282; 330/284; 330/86	Lin; Syh- Shoei et al.
US 6576483	20030610	Backside cannelure to	438/14	118/690;	Chou;

B1		provide for wafer shift detection		356/614; 438/5; 438/800	Ching-Hian et al.
US 6571607 B2	20030603	Fluid leak detection via thermal sensing	73/40	73/25.03; 73/40.5R; 73/61.46	Jang; Ruei- Hung et al.
US 6549278 B2	20030415	Contaminant inspecting device with multi-color light source	356/237.2	356/237.1; 356/239.1; 356/239.2; 356/239.8	Tseng; Wen Nan
US 6549029 B1	20030415	Circuit and method for measuring capacitance	324/769	324/765	Hsieh; Tsung- Hsuan et al.
US 6522526 ·B2	20030218	TCNQ complex and its application in solid electrolytic capacitors	361/523	29/25.03; 361/518; 361/525; 361/528	Tsai; Li- Duan et al.
US 6521300 B1	20030218	Method of a surface treatment in improving adhesion of an organic polymeric low-k dielectric layer	427/539	257/E21.259; 257/E21.266; 257/E21.293; 427/240; 427/577; 427/578; 427/579	Hsieh; Tsung-Tang et al.
US 6513542 B1	20030204	Liquid supply or drain pipe equipped with a leakage detector	137/312	137/486; 137/487.5; 137/554; 137/557; 340/605; 340/606; 340/608; 73/40.5R	Hsieh; Tsung-Chi
US 6510248 B1	20030121	Run-length decoder with error concealment capability	382/233	341/59; 382/245	Hsieh; Tsung- Hsien
US 6501438 B2	20021231	Multiband helical antenna	343/895		Nevermann; Peter et al.
US 6495915 B1	20021217	Flip chip package of monolithic microwave integrated circuit	257/728	257/684; 257/691; 257/724; 257/725; 257/734; 257/737; 257/738; 257/774; 257/778;	Hsieh; Tsung-Ying et al.

				257/796; 257/E21.511	
US 6495813 B1	20021217	Multi-microlens design for semiconductor imaging devices to increase light collection efficiency in the color filter process	250/208.1	250/216; 257/E27.131	Fan; Yang- Tung et al.
US 6489227 B1	20021203	Method of etching a polysilicon layer during the stripping of the photoresist shape used as an etch mask to create an opening to an underlying fuse structure	438/601	257/E21.255; 257/E21.309; 257/E23.15; 438/132; 438/215; 438/622; 438/624; 438/634; 438/637	Hsieh; Tsung-Chi et al.
US 6483186 B1	20021119	High power monolithic microwave integrated circuit package	257/707	257/705; 257/712; 257/717; 257/728; 257/E23.092; 257/E23.125	Hsieh; Tsung-Ying et al.
US 6474014 B1	20021105	Exhaust ventilator capable of driving away mosquitoes	43/98	43/112; 43/119	Yu; Fang- Chun
US D465044 S	20021029	Gas lamp	D26/40		Hsieh; Tsung-Han
US 6468704 B1	20021022	Method for improved photomask alignment after epitaxial process through 90.degree. orientation change	430/22	257/E23.179	Liao; Chi- Hung et al.
US 6467848 B1	20021022	Chair having a reinforced attaching mechanism	297/445.1	297/383	Gien; Gin Chong et al.
US 6463649 B1	20021015	Method of manufacturing disposable reaction module	29/434	422/58	Lai; Lih- Huey et al.
US 6459413 B1	20021001	Multi-frequency band antenna	343/702	343/700MS; 343/895	Tseng; Wen-Jen et al.
US 6452631 B1	20020917	Method and apparatus for forming high contrast image in imaging system	348/254	382/254	Hsu; Chuan-Yu et al.
US 6445008 B1	20020903	Photo sensing device and the manufacturing	257/82	257/100; 257/E25.032;	Lin; Ming- Der et al.

-		method thereof		257/E31.105	
US 6443855	20020903	Head of a golf club	473/326	473/329;	Tseng;
B1				473/333	Wen-Cheng
US D461548	20020813	Heater	D23/342		Hsieh;
S		·			Tsung-Han
US 6417022	20020709	Method for making long	438/70	438/72	Hsiao; Yu-
B1		focal length micro-lens			Kung et al.
		for color filters			
US 6407990	20020618	Method of transmission	370/335	370/479;	Li; Yingtao
B1		of image by CDMA		455/69	et al.
		system			
US 6398381	20020604	Wind-driven perfume	362/96	362/234;	Tseng; Wen
B1		dispenser capable of	3+3	362/253;	Yung
		producing different light		362/276;	
		patterns		362/800;	
			,	362/802;	
		*		362/806	
US 6396460	20020528	Chip antenna	343/895	343/760	Tseng;
B2			•	!	Wen-Jen et
					al.
US 6395576	20020528	High efficiency color	438/70	257/E27.132;	Chang;
B1		filter process to improve	•	438/65	Chih-Kung
	:	color balance in			et al.
		semiconductor array	ļ		
		imaging devices			
US 6374996	20020423	Circuit board carrier	198/750.12	198/468.4;	Hsieh;
В1				414/752.1;	Tsung-
		·		414/797;	Chang
	ļ			901/16;	
				901/17	
US 6360756	20020326	Wafer rinse tank for	134/95.3	134/102.1;	Chen; Chie-
B1]	metal etching and method		134/902;	Chi et al.
		for using		134/95.1	
US 6338182	20020115	Hinge assembly	16/386	16/229;	Tseng;
B1				16/262;	Wen-Hung
				16/387;	et al.
			.	361/680;	
				361/686;	
1				439/165;	
				439/31	
US D452092	20011218	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest .			Wen-Hung
US D451720	20011211	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung
US D451719	20011211	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung

US D451718	20011211	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung
US D451717	20011211	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest	·		Wen-Hung
US D451716	20011211	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung
US D451715	20011211	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung
US D451316	20011204	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung
US D451315	20011204	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung
US D451314	20011204	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung
US D451313	20011204	Combined chair	D6/500	D6/366	Tseng;
S		seat/backrest			Wen-Hung
US 6288265	20010911	Phloroglucidic acid and	560/51	560/57;	Hwu; Jih
B1	20010511	derivatives as		562/460;	Ru et al.
D1		antibacterial agents		562/468;	
		antibueteriai agents		564/169;	
				564/170;	
				564/177	
US 6284195	20010904	Disposable reaction	422/58	422/102;	Lai; Lih-
B1	20010701	module	1.22,00	422/103;	Huey et al.
D 1		module		422/63	
US 6281140	20010828	Method of reducing the	438/763	257/E21.193;	Chen; Chie-
B1	20010020	roughness of a gate		257/E21.241;	Chi et al.
l B1		insulator layer after		257/E21.25;	
		exposure of the gate		257/E21.337;	
	Ì	insulator layer to a		438/289;	
		threshold voltage		438/594;	
		implantation procedure	•	438/787	
US 6274917	20010814	High efficiency color	257/432	257/232;	Fan; Yang-
B1	20010011	filter process for		257/233;	Tung et al.
		semiconductor array		257/435;	
α.		imaging devices		257/E27.132	•
US 6272866	20010814	Micro cooling engine	62/3.1	257/E23.098;	Tsai; Ming-
B1	20010011	array system	02,011	62/259.2;	Jye et al.
D1		array system		62/6	
US 6272630	-20010807	Method and device for	713/2		Chen;
B1	20010007	reserving wake-up			Tseng-Wen
		functions of computer	·	•	et al.
		system after power loss			
US D444327	20010703	Chair armrest	D6/501	D6/366	Tseng;
S D444327	20010703				Wen-Hung
US 6238160	20010529	Method for transporting	414/217	29/25.01;	Hwang;
03 0230100	20010323	Triction for transporting	1 11 11 22 1		

B1		and electrostatically		414/935;	Yuan-Ko et
D .		chucking a		414/941	al.
		semiconductor wafer or			
		the like			
US 6229121	20010508	Integrated thermal	219/505	219/511;	Jang; Ruei-
B1		buckling micro switch		337/107;	Hung et al.
		with electric heater and		337/298	
		sensor			
US 6221396	20010424	Oral cisapride dosage	424/482	424/474;	Chao;
B1		forms with an extended		424/490;	Shouchung
	·	duration		424/494;	et al.
				424/497	
US 6206022	20010327	Integrated flow controller	137/15.18	137/486;	Tsai; Ming-
B1	, ,	module		251/11	Jye et al.
US D439083	20010320	Chair armrest	D6/501	D6/366	Tseng;
S					Wen-Hung
US 6205251	20010320	Device and method for	382/233	382/246;	Hsieh;
B1		decompressing		382/298	Tsung-
		compressed video image			Hsien et al.
US 6185085	20010206	System for transporting	361/234		Hwang;
B1		and electrostatically			Yuan-Ko et
		chucking a			al:
		semiconductor wafer or			
		the like			
US 6171885	20010109	High efficiency color	438/70	257/E27.132;	Fan; Yang-
B1		filter process for		438/72	Tung et al.
		semiconductor array			
		imaging devices			
US 6143579	20001107	Efficient method for	438/17	257/E21.53;	Chang;
A		monitoring gate oxide	-	438/14	Chia-Der et
		damage related to plasma			al.
		etch chamber processing			
		history			
US 6141119	20001031	Imaging cartridge for a	358/498	358/474	Tseng;
Α	:	computer system			Wen-Tso et
					al.
US 6124632	20000926	Monolithic silicon mass	257/678	257/706;	Lo; Lieh-
A		flow control structure		257/714;	Hsi et al.
				257/723	TT T'1
US 6121255	20000919	Phloroglucide derivatives	514/200	514/209;	Hwu; Jih
Α.		and their pharmceutical		540/215;	Ru.et al.
		use		540/230;	
				560/52;	
				560/57;	
		•		562/460;	
				562/468;	<u> </u>

				564/169;	
				564/171	
US 6107202	20000822	Passivation photoresist stripping method to	438/690	257/E21.255; 257/E21.581;	Chiu; Chih- Kang et al
A		eliminate photoresist	•	438/120;	Traing or an
·		extrusion after alloy		438/618; 438/700;	
				438/750; 438/781;	
				438/906;	
:				438/948; 438/963	
US 6105568 A	20000822	Diamond wire saw	125/18	125/16.02; 125/21; 125/22;	Yu; Fang- Chun
				83/651.1	
US 6103633 A	20000815	Method for cleaning metal precipitates in	438/720	257/E21.295; 257/E21.305; 257/E21.584;	Shen; Yun- Hung et al.
		semiconductor processes		438/734; 438/742	
US 6089969 A	20000718	Powder-proof apparatus for a PECVD reactor chamber	454/56		Chung; Min-Yuan et al.
US 6045111 A	20000404	Fixing sucker structure	248/551	248/205.8; 248/362; 248/503	Hsieh; Tsung-Hsi
US 6033987 A	20000307	Method for mapping and adjusting pressure distribution of CMP processes	438/692	216/88; 257/E21.23; 438/633; 438/747;	Lin; Chi-Fa et al.
		Processes		451/285; 451/384; 451/41	
US 6032689 A	20000307	Integrated flow controller module	137/486	137/487.5; 251/11	Tsai; Ming- Jye et al.
US 6024261 A	20000215	Model having a foldable limb	223/66	223/71; 403/122; 403/128	Tseng; Wen Hui
US RE36511 E	20000118	Ejector for a tray device	720/609	360/99.06	Liou; Dong- Yih et al.
US 5988627 A	19991123	Paper-feeding apparatus	271/110	271/118; 271/126; 271/152	Lin; Chin-I et al.
US 5954327 A	19990921	Paper-feeding apparatus	271/110	271/152 271/118; 271/126;	Lin; Chin-I et al.

				271/155; 271/157	
US 5923138	19990713	Manually-operated	318/560	318/569;	Kuo; Lun-
A 3923136	19990713	handwheel interpolation-	310/300	318/572;	Yu et al.
A		generating device		318/573	2 62 65 652
US 5913383	19990622	Fire escape device for	182/236	182/6; 182/7;	Tseng;
A	19990022	lowering people from a	102/230	182/71;	Wen-Tsai
A		high rise		182/73	
US 5880019	19990309	Insitu contact descum for	438/666	257/E21.507;	Hsieh;
A	15550505	self-aligned contact	,	257/E21.577;	Chin-Chuan
A		process		438/701;	et al.
		process		438/723;	
	·			438/725;	
		·		438/906	
US 5861946	19990119	System for performing	356/150	356/138;	Hudson;
A		contact angle		356/154;	David M. et
•-		measurements of a	1	356/399;	aļ.
		substrate		356/614	
US 5839555	19981124	Automatic clutch type	192/223.1	160/310;	Hsieh;
A		chain pulling mechanism		49/140;	Tsung-Wen
		for a motor rolling door		74/625	
US 5820689	19981013	Wet chemical treatment	134/3	134/10;	Tseng;
A		system and method for		134/104.1;	Wen-
		cleaning such system		134/108;	Hsiang et
•				134/111;	al.
				134/25.4;	
			ľ	134/26;	İ
				134/28;	
•				134/41;	
				134/902	·
US 5815329	19980929	Tri-mirror multi-	359/861	359/726;	Tseng;
A		reflection optical path		359/850;	Wen-Tso
		folding apparatus	0.5.6/1.0.4	359/857	T.
US 5793482	19980811	Multiple optical lens	356/124	250/201.4;	Tseng;
A		system with auto-focus		356/124.5;	Wen-Tso et
		calibration	172/206	356/125	al.
US 5788587	19980804	Centroid-adjustable golf	473/326	473/329;	Tseng;
A		club head		473/332;	Wen-Cheng
****	1000000	T C 1 1 11 11	266/120	473/333	Teener
US 5788369	19980804	Infant nursing bottle with	366/130	215/11.2;	Tseng; Wen-Pin
A	10000707	mixing element	120/660	215/DIG.8	Hsieh;
US 5776832	19980707	Anti-corrosion etch	438/669	257/E21.313; 438/688;	Chia-Dar et
A		process for etching metal		438/720;	al.
		interconnections		438/725	ai.
		extending over and		430/123	
	<u></u>	within contact openings		1	<u> </u>

US 5706552	19980113	Apparatus for preventing	16/82	16/310;	Hsieh;
Α		a motor rolling door from		16/DIG.10;	Tsung-Wen
		falling		49/322	
US 5694907	19971209	Gasoline engine booster	123/587		Tseng;
A					Wen-Chih
US 5668035	19970916	Method for fabricating a	438/239	257/E27.081;	Fang;
Α		dual-gate dielectric		438/241;	Chung Hsin
		module for memory with		438/287	et al.
		embedded logic			
•		technology			
US 5660561	19970826	Lamp bulb socket	439/419	439/340	Tseng;
A					Wen-Ling
US 5632549	19970527	Fastener frame with	362/108	362/103;	Fang;
A		button switch		362/252;	Chung-Ho
				362/800	
US 5616527	19970401	Composite ceramic	501/97.2	501/98.1	Kita; Hideki
Α					et al.
US 5591687	19970107	Silicon nitride based	501/97.2		Kita; Hideki
A		sintered product			et al.
US 5579878	19961203	Bi-directional clutch type	192/223	192/144	Hsieh;
A		chain pulling device for			Tsung-Wen
		rolling doors			
US D375808	19961119	Electro luminescent night	D26/26	D26/72	Fang;
S		light			Chung-Ho
US 5561653	19961001	Ejector for a tray device	720/609	360/99.06	Liou; Dong-
A					Yih et al.
US 5556806	19960917	Spin-on-glass	438/624	257/E21.294;	Pan; Sheng-
Α .		nonetchback		257/E21.58;	Liang et al.
		planarization process		438/631;	
		using oxygen plasma		438/763;	
		treatment	D06/06	438/964	Г
US D368537	19960402	Electro luminescent night	D26/26	*	Fang;
S	100000	light	D26/26		Chung-Ho
US D368536	19960402	Electro luminescent lamp	D26/26	·	Fang;
S	1006000		101/22	101/121 5.	Chung-Ho
US 5493966	19960227	Stamping machine for	101/23	101/131.5;	Tseng;
A		printing patterns on a		101/33	Wen-chung
		blind slat and a method			
110 5001010	10050110	using such a machine	262/100	22/760:	Fang;
US 5381318	19950110	Portable light generating	362/108	33/760; 33/767;	Chung-Ho
A		belt device		33/707;	Chang-110
				362/103;	
				362/103,	
110 5255741	10041019	Failsafe limit switch with	74/2	160/293.1;	Hsieh;
US 5355741	19941018			74/500.5	Tsung W.
A		automatic reset for rolling	<u> </u>	1 17100.0	Tourig VV.

•		fire door			
US 5320700 A	19940614	Process for molding utilizing compression sleeve	156/309.6	156/245; 264/258; 264/338	Hall; Charles M. et al.
US 5229699 A	19930720	Method and an apparatus for PID controller tuning	318/610	700/37; 700/42	Chu; Yao- Tung et al.
US 5175791 A	19921229	Fragrance diffuser having stepped power levels	392/390	219/492; 219/497; 219/501; 261/DIG.89; 422/122	Muderlak; Kenneth J. et al.
US 4988630 A	19910129	Multiple beam laser instrument for measuring agglutination reactions	436/533	422/73; 435/7.1; 435/808; 436/164; 436/534; 436/807	Chen; Fang- Chung et al.
US 4975387 A	19901204	Formation of epitaxial sige heterostructures by solid phase epitaxy	438/486	117/8; 117/9; 117/930; 148/33.4; 148/DIG.154; 148/DIG.3; 148/DIG.48; 148/DIG.59; 148/DIG.72; 257/E21.129; 438/505	Prokes; Sharka M. et al.
US 4867627 A	19890919	Multi-floor elevating parking station	414/249	187/259; 188/32; 384/57; 384/58; 414/264	Tseng; Wen-Kung
US 4506803 A	19850326	Metered aerosol dispenser and method of using the dispenser	222/1	222/402.2	Franklin; Michael L. et al.
US 4505023 A	19850319	Method of making a planar INP insulated gate field transistor by a virtual self-aligned process	438/285	257/268; 257/280; 257/289; 257/E21.341; 257/E21.342; 257/E21.441; 257/E29.04; 257/E29.089; 257/E29.255; 438/522; 438/523	Tseng; Wen F. et al.